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Roll-to-roll infrared and hot-air sintering of  
gravure-printed Ag layer based on *in situ* tension  
measuring and analysis†Janghoon Park,<sup>‡a</sup> Hyi Jae Kang,<sup>‡a</sup> Hyogeun Gil,<sup>a</sup> Kee-Hyun Shin<sup>ab</sup> and  
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This study presents a method developed to achieve the roll-to-roll sintering of printed Ag patterns based on exposure to hot air, near-infrared, and mid-infrared sources. The sintering energy was quantified and evaluated based on theoretical and experimental calculations. Moreover, the effect of the sintering energy on the web tension was simultaneously considered.

The sintering of a metal layer processed in a solution is necessary to improve its electrical performance in printed electronic devices.<sup>1</sup> Several sintering (*e.g.* hot air,<sup>2</sup> electric,<sup>3</sup> microwave,<sup>4</sup> and plasma<sup>5</sup>) and photonic [*e.g.* infrared (IR),<sup>6</sup> ultraviolet (UV),<sup>7</sup> laser<sup>8</sup> and intense pulsed light (IPL)] techniques have been used.<sup>9–11</sup> Recent research aimed at enhancing the effectiveness of the sintering performance achieved results within a few seconds<sup>6</sup> or milliseconds,<sup>10</sup> which means that the metal layers approached the conductivity of bulk metals.<sup>2</sup>

The roll-to-roll (R2R) system increasingly requires an effective sintering approach because of its limited processing footprint at the web span. In addition, a thermally damaged substrate affects the tension control performance by introducing strain and elastic modulus changes.<sup>12,13</sup> Instability in the tension control can lead to a decline in the register control of the multi-layered printed layer,<sup>12</sup> which eventually affects the yield of the electronic product.<sup>14</sup> Considerable research has been devoted to the analysis of damage to the substrate according to the crack<sup>10</sup> or peel strength<sup>15</sup> of the layer responsible for the appearance of the final products.<sup>16</sup> However, the web-handling performance (tension) in conjunction with the sintering performance has not been studied.

Our work involved the introduction of a large-area R2R inline sintering process, using a hot air oven [Fig. 1(a)] and photonic

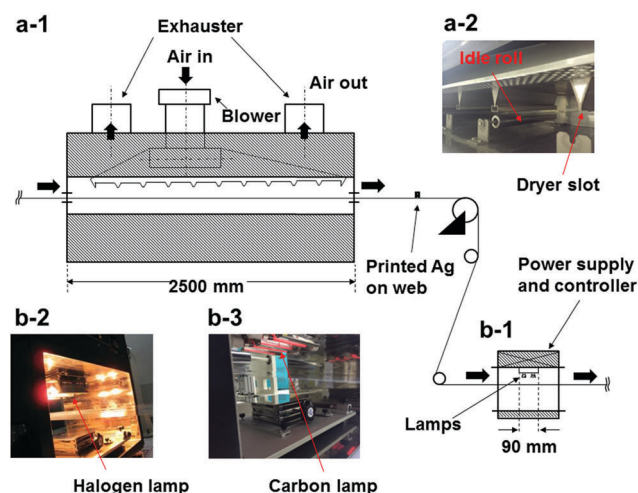


Fig. 1 Schematic diagram and photographs describing a part of the large-area R2R sintering module on an Ag-layer printed on a moving plastic substrate, with (a-1) and (a-2) representing the hot air oven system with an effective exposure area of  $350 \times 2500 \text{ mm}^2$ , and (b-1) showing the photonic system with an effective exposure area of  $350 \times 90 \text{ mm}^2$ ; (b-2) and (b-3) indicate the setup of the halogen and carbon lamps for the NIR and MIR sintering processes, respectively.

exposure [near-infrared (NIR) and mid-infrared (MIR), DTX Co. Ltd, Korea] [Fig. 1(b)]. An R2R gravure printing system (SungAn Machinery Co., Ltd, Korea)<sup>2</sup> was used as the main platform. Gravure printing was conducted on a 300 mm width polyethylene terephthalate (PET) web (SH-34, SKC Co. Ltd, Korea) by using Ag paste (FLT-770G, FP Co. Ltd, Korea). The patterns printed on the PET substrate were dried and the substrate was rewound after the printing process. The length, width, and thickness of these printed patterns after gravure printing and drying at  $90 \text{ }^\circ\text{C}$  for 2.5 min were 88 mm, 10 mm, and  $1.67 \pm 0.3 \text{ }\mu\text{m}$ , respectively.

The line resistances were measured six times within the sampled pattern on the lengthy film by using a source meter (2611A, Keithley Co. Ltd, USA). The resistance values decreased from the initial value of  $2.8 \pm 0.45 \text{ k}\Omega$  to  $884 \pm 118 \text{ }\Omega$  at a

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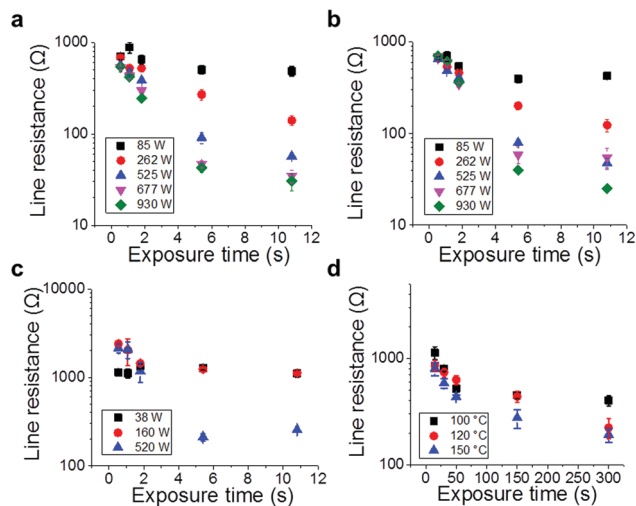
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**Fig. 2** Semilogarithmic plot of line resistance as a function of the exposure time with different experimental conditions with respect to the power or temperature input. Photonic sintering with (a) NIR with a 70 mm distance between the lamp and the substrate, (b) NIR with a 35 mm distance and (c) MIR with a 35 mm distance using a different amount of power from the lamp. (d) Hot air in the oven chamber, showing the effect of the temperature changes.

distance of 70 mm (between the lamp and the substrate) after 1.08 s of exposure time and 85 W of exposure power [Fig. 2(a)]. In all sintering cases, the highest conductivity with the shortest sintering time was obtained as  $532 \pm 21 \Omega$  at 70 mm with 677 W power and 0.54 s sintering time. The standard deviation was very large (*i.e.* 21  $\Omega$ ) for the resistance values of the overall patterns obtained after a short exposure time, because of the incompleteness of particle agglomeration. However, the deviation was minimised when the exposure time was increased. The resistance was  $25 \pm 2 \Omega$  with 930 W power at a 35 mm distance when the exposure time was increased to 10.8 s. This result shows an improvement of approximately 2500%, compared to the samples sintered for 1.08 s. Linear scale plots of the line resistances plotted in Fig. 2 are provided in the ESI.†

For the MIR sintering, the carbon lamp was set to 2.99 A at 174 V. For NIR sintering, the halogen lamp was set to 3.89 A at 174 V. The carbon lamp resistance was higher than that of the halogen lamp. Hence, the total power was different, even though the lamp voltages were the same. Moreover, the 70 mm distance with MIR exposure indicated less effectiveness. The line resistance at 520 W power did not decrease when the resistance was over 1 k $\Omega$ . Furthermore, no relationship was observed with respect to exposure times (see ESI†). A comparison of these two sintering methods showed a line resistance of  $256 \pm 11 \Omega$  at a 35 mm distance, a 10.8 s exposure time, and 520 W power [Fig. 2(c)]. This value was poor compared to the NIR result obtained at a similar power, producing a result 540% worse than the  $47.3 \pm 11 \Omega$  obtained with an NIR power of 525 W. The line resistance during hot-air sintering remained constant as the temperature and exposure times increased [Fig. 2(d)]. The best result obtained with hot air was  $193 \pm 29 \Omega$  at 150 °C for 300 s.

The sintering performance could be quantified in terms of the energy density of the power source. An energy meter (Vega, OPHIR Photonics Co. Ltd, USA) was used to measure the photonic energy from the lamp across a 35 mm distance for a 1 s duration. The measured representative energy can be expressed as the curve fitting equation:  $e_1 = (-3 \times 10^{-6} \cdot P^2 + 0.0072P + 1.5088) \cdot 3.5^2$ , where  $e_1$  is the measured power, and  $P$  is the input lamp power. Accordingly, the total energy density radiating from the lamp was calculated using eqn (1) as follows:<sup>6,17</sup>

$$E_D = \frac{e_1 D_c}{d^2} \quad (1)$$

where  $E_D$ ,  $D_c$ , and  $d$  are the total energy density, the exposure duration (seconds), and the distance between the lamp and the substrate, respectively. The denominator of eqn (1) originated from the inverse-square law. The light intensity was inversely proportional to the square of the distance from the light source. The calculated energy densities ranged from 0.28 to 60.6 J cm<sup>-2</sup>;  $e_1$  can generally be substituted as  $P$ , which could be obtained as a product of the voltage ( $V$ ) and the current ( $I$ ). A comparison of the density measured with the energy meter,  $e_1$ , and the calculated energy density from the lamp input,  $P$ , is provided in the ESI.† The measured actual values showed a large discrepancy of 13–15% of the calculated values. However, some linearity was also found. The calculated value was based on the electrical input: however, there were huge losses due to generated heat, scattering on air, and the body of the sintering module. The calculation without the measurement data can thus be theoretically utilised to understand the physical effect of the lighting sources.

The temperature measured in the oven can be expressed as a curve-fitting equation to represent the rise from room temperature to 150 °C ( $T_c = 0.4883s + 18.806$ ;  $T_c$ : temperature in °C, and  $s$ : time in seconds). As reported by Hebbar *et al.*,<sup>18</sup> long ovens must achieve a thermodynamic equilibrium, in which the heat they emit must be equal to the total quantity of heat absorbed and lost by the web, oven wall, *etc.* The electrical heater of the oven supplied 60 kW, which formed the major input to the area. Thus, the heat loss from the wall and the web can be omitted to calculate the ambient temperature in the oven. In this manner, the required energy in the oven can be calculated by using the following equation:<sup>19</sup>

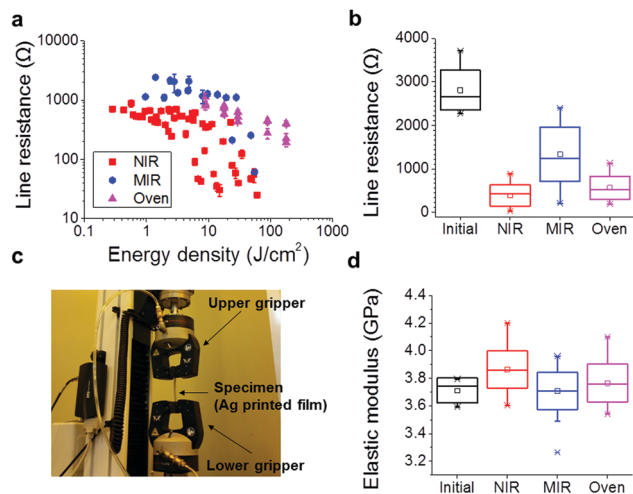
$$E = c_p \rho V \Delta T \quad (2)$$

where  $E$  is the quantity of heat energy needed to produce the rising heat in the oven;  $c_p$  is the specific heat capacity of air [1 J (g K)<sup>-1</sup>];  $\rho$  is the air density (1275 g m<sup>-3</sup>);  $V$  is the air volume inside the oven (0.2275 m<sup>3</sup>); and  $\Delta T$  is the temperature change from room temperature to the specified value in K (variation amounts: 75, 95, and 125 K). The total energy requirements for the set value ( $E$ ) at 100, 120, and 150 °C were obtained as 21.8, 27.6, and 36.3 kJ, respectively. The required power density of the oven ( $P_D$ ) can be expressed as follows:

$$P_D = \frac{E}{sA} \quad (3)$$

where  $s$  is the required rising time in seconds, and  $A$  is the substrate area (0.75 m<sup>2</sup>). The time  $s$  for each set temperature





**Fig. 3** Energy exposure density as a function of the conductivity of the Ag pattern and the film deformation. (a) Line resistance for each experimental condition (*i.e.* NIR, MIR, and hot air oven). (b) Box charts of the line resistance and as various experimental sets (*i.e.* initial pattern, NIR, MIR and oven-sintered patterns). (c) Photograph of the tensile tester with a specimen of the Ag-printed and sintered sample. (d) Resulting box charts of the elastic modulus of the plastic web, wherein each of the Ag layers were printed and sintered.

was derived as 170, 220, and 270 s based on the measured curve-fitting data. Hence, the  $P_D$  of the oven heater for every temperature was obtained as  $0.59 \pm 0.02 \text{ J cm}^{-2}$ . The calculation of the exposure duration using eqn (1) enabled the  $E_D$  of the convection energy density in the oven to be calculated as a distribution from 8.9 to  $177.9 \text{ J cm}^{-2}$  [Fig. 3(a)].

NIR radiation exposure was more effective in reducing the resistance than any other heat sources [Fig. 3(a)]. Interestingly, the NIR and MIR modules were more effective than the hot air oven, which supplied 60 kW power, even though they only provided about 1 kW electric power. The conductivity could not be calculated because of the roughness of the gravure-printed surface. Hence, the reduction in the relative line resistance was analysed in this study. Compared with the nano-sized ink particles, the flake particles required higher power and more time to agglomerate to larger-sized particles [see ESI†].<sup>2</sup>

The meta-equations of the NIR and MIR cases in the experiment can be suggested as follows as eqn (4) and (5), respectively, from the curve-fitted equation of Fig. 3(a):

$$R_{\text{NIR}} = 455.8e^{-0.054E_D} \quad (4)$$

$$R_{\text{MIR}} = 1817e^{-0.041E_D} \quad (5)$$

where  $R_{\text{NIR}}$  and  $R_{\text{MIR}}$  are the line resistances for the NIR and MIR lamp cases, respectively. The exponential fitting of the theoretically calculated energy density to the line resistance was indicated in the ESI.† The fitted meta-functions showed similarity. The energy density calculation from the lamp power was again confirmed to have a significant physical meaning with respect to the actual phenomenon of the sintering process.

The box charts present information on the distribution of all the processed samples [Fig. 3(b)]. The average values showed

that the exposure to NIR, MIR, and heat radiation in the oven resulted in an improvement of 516%, 150%, and 352% compared to the initial resistance (*i.e.* 2.8 kΩ). The results demonstrated that the MIR radiation can achieve a lower resistance. However, its standard deviation was high because of the incompatibility with the Ag layer and the PET film. As Cherrington *et al.* reported,<sup>20</sup> the absorbance of infrared energy by the PET substrate increased as the wavelength increased from the NIR range to the MIR range. The same amount of MIR and NIR energy clearly affected not only the Ag layer, but also the PET substrate. An absorbance difference between the PET and the Ag layer was apparent (see ESI†). The PET absorbance in the 400–1100 nm wavelength range was almost negligible, in marked contrast to that of the Ag layer. Moreover, the NIR induced local damage near the Ag layer, whereas the MIR only caused shrinkage around the films.

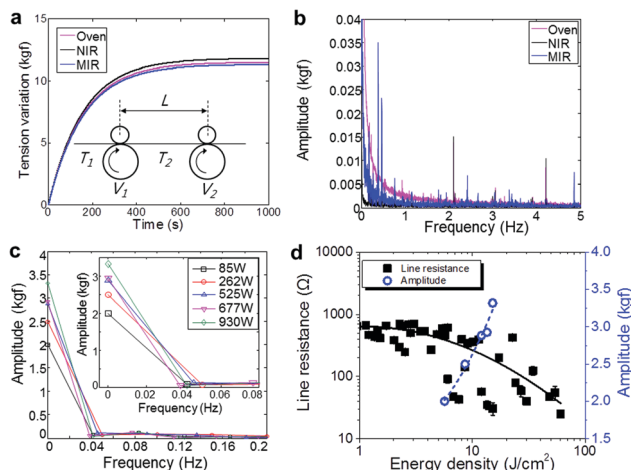
The fully Ag-printed pattern was sintered and slotted with a size of 10 mm × 88 mm for the tensile test. The test was conducted according to ASTM D882 by using a universal tester [Instron 3343, USA, Fig. 3(c)].<sup>21</sup> The standard deviation of the elastic modulus of the initial specimen was low (*i.e.* 81 MPa) compared with that of the sintered specimen (*i.e.* 136 MPa) [Fig. 3(d)]. The energy exposure modified the PET web properties in the form of expansion and shrinkage.<sup>2,13</sup> The elastic modulus of the NIR-sintered specimen was obtained as  $3.86 \pm 0.135 \text{ GPa}$ , which was the highest value for the experimental conditions. Meanwhile, the corresponding data for the samples subjected to MIR and heat exposure (oven) were  $3.7 \pm 0.136$  and  $3.76 \pm 0.137 \text{ GPa}$ , respectively.

The standard deviation of the elastic modulus of the sintered sample was similar overall, thereby implying the reliable significance of its value for each case. Exposure to NIR radiation clearly resulted in a higher elastic modulus because of the shrinkage attributed to the rapid temperature change with the effective energy absorbance by the Ag layer. The elastic modulus can affect the tension response of the R2R system. The linearized tension model in the upstream and downstream span [inset of Fig. 4(a)] can be expressed as follows:<sup>22</sup>

$$\frac{d}{dt}[T_2(t)] = -\frac{v_{\text{op}}}{L}T_2(t) + \frac{v_{\text{op}}}{L}T_1(t) + \frac{A_c E_w}{L}[V_2(t) - V_1(t)] \quad (6)$$

where  $T_1$ ,  $T_2$ ,  $v_{\text{op}}$  ( $5 \text{ m min}^{-1}$ ),  $L$  (13 m),  $A_c$  ( $30 \times 10^{-6} \text{ m}^2$ ),  $E_w$ ,  $V_2$  and  $V_1$  are the upstream tension, downstream tension, operating velocity, span length, cross-sectional area of the web, elastic modulus of the web, and the change in the web velocity from a steady-state operating value at the first and second rollers, respectively. In this mathematical model,  $E_w$  was the most effective parameter, hugely affecting the tension variation of  $T_2$  because of its high order (*i.e.* approximately  $10^9$ ). The open-loop tension response was simulated by measuring the elastic modulus of the samples exposed to oven-heating, NIR, and MIR [Fig. 4(a)]. The step input of the driven roll velocity was very small at  $8.3 \times 10^{-5} \text{ m s}^{-1}$  (1/1000 of the operating speed). The tension variation at the steady state of each condition was 11.78, 11.48, and 11.29 kgf for the NIR, oven, and MIR, respectively. A high tension variation was found because the substrate was





**Fig. 4** Effect of the sintering sources (*i.e.* oven, NIR and MIR) on the web property changes. (a) Step input response of  $T_2$  when  $V_1$  was changed by 1/1000 of the operating velocity [inset: schematic diagram of a free web span]. (b) FFT results for the PET substrate of the acquired tension data from the load cell with various sintering sources. (c) FFT results for the Ag-printed PET substrate of the acquired tension data with various NIR lamp powers (inset: zoomed graph from 0 Hz to 0.08 Hz). (d) Comparison between the line resistance of the Ag pattern and the amplitude as energy density.

thermally damaged, and the elastic modulus changed to the highest value under the NIR conditions. MIR and NIR treatment resulted in a tension variation gap of about 490 g, which could generate a serious register error of  $\pm 600 \mu\text{m}$  in multi-layer printing.<sup>12,23</sup>

The simulation was conducted by considering the elastic moduli of the printed and sintered Ag patterns, wherein Ag was uniformly spread across the web substrate. However, the patterns were only partly located on the web according to the complexity of their pattern designs. A previous study<sup>6</sup> found the PET substrate to be a good transmitter of NIR radiation, most of which was absorbed by the deposited Ag layer. The transmittance affected the tension variation of a moving substrate in the R2R system. The inline data acquisition for the R2R system, measured by using a load cell, showed the effect of the NIR radiation energy on the bare (not Ag printed) PET substrate [Fig. 4(b)]. A fast Fourier transform (FFT) was conducted using the web tension data for a 600 s driving time of the R2R system at a  $5 \text{ m min}^{-1}$  velocity. The measurement was started with the heat source turned on (full power: 930 W for the NIR and MIR and  $150 \text{ }^\circ\text{C}$  for the oven). Among the conditions, the ‘oven’ data showed a high amplitude because of the long transient time taken to reach the specified temperature value. The tension markedly increased to 5 kgf after the oven was turned on for 300 s. This value was five times higher than the specified value. In addition, the MIR data indicated a higher peak than the NIR. The wavelength range of the MIR energy was suitable for PET absorbance. However, the bare PET film exhibited almost no damage after NIR radiation exposure. This result implied that the existence or non-existence of the printed pattern around the PET film can determine the extent of the damage caused by the

photonic source, especially the NIR lamp. The effect of the patterned area on the amount of damage will be determined in further studies.

The line resistance of the Ag-printed patterns and the tension variation herein were simultaneously compared. The lamp power in Fig. 4(c) was varied to 85, 262, 525, 677, and 930 W. The tension data were acquired during the same time. The tension was measured with a 2 kgf operating tension,  $2 \text{ m min}^{-1}$  web velocity, and 35 mm distance. The FFT result clearly showed a relationship between the web tension and the lamp power. The energy density for each lamp power can be obtained as 5.7, 8.6, 12, 13.5, and  $15.1 \text{ J cm}^{-2}$  based on the experimental conditions. This result demonstrated that the line resistance and the tension variation were inversely proportional [Fig. 4(d)]. The tension value could be increased to 2, 2.5, 2.8, 2.9, and 3.3 kgf at a frequency of 0 Hz as the energy density increased, which indicated the mean tension value. These tension changes were clearly caused by a change in the elastic modulus of the PET when the PET web underwent expansion and shrinkage. The electrical performance of the electrode and the web handling performance should be considered simultaneously for the R2R sintering. Therefore, the production guidelines related to the conductivity of patterns or the operating tension ranges could determine the optimised energy density during the sintering process. As mentioned earlier, the areas of Ag and of the pattern will determine the NIR energy absorbance by the moving web. The exact absorbance rate could not be quantified at all times. Thus, these guidelines should be followed based on the exact experimental data and quality index (*e.g.* specific tension range), and the targeted electrical performance.

NIR, MIR, and hot air were compared as sintering sources for the Ag patterns on the moving PET substrate. NIR showed an excellent performance, which was obtained as  $25 \pm 2 \Omega$  with 930 W power at a 35 mm distance. The quantification of each sintering method was also performed and compared. The results indicated that photonic sintering was the most effective technique for obtaining a good electrical performance, while NIR was the most efficient when the energy density was considered. Accordingly, the simulated and measured tension data obtained for the R2R system showed the advantages and disadvantages of NIR sintering with respect to the existence of an Ag pattern printed on the PET substrate. Sintering with a higher energy can improve the electrical performance of an electrode. However, the tension was varied with an amplitude of 0 to 1.3 around the set value of tension, according to the energy density change. Therefore, the perspective of tension variation and exact operating ranges should be considered when associating change with the web properties, as shown in this research.

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